



# 107A RESIN 9292B HARDENER

THIXOTROPIC COLD-MOLDING EPOXY RESIN SYSTEM  
TECHNICAL DATA BULLETIN

## SYSTEM BENEFITS:

CPD 107A Resin with CPD 9292B Hardener is a rapid setting, low viscosity, thixotropic general purpose epoxy resin system that may be used in many diverse applications such as laminating, coating and bonding.

- Thixotropic cold-molding
- Simple 3:1 mix ratio by volume
- Rapid setting

### HANDLING PROPERTIES

	CPD 9292B	Test Method
Resin Density at 25°C, lbs/gal	9.7	ASTM D1475
Hardener Density at 25°C, lbs/gal	8.1	ASTM D1475
Resin Viscosity at 25°C, cP	2,500	ASTM D2196
Hardener Viscosity at 25°C, cP	40	ASTM D2196
Initial Mixed Viscosity 25°C, cP	590	ASTM D2196
Mix Ratio by Weight	100A : 30B	Calculated
Mix Ratio by Volume	3A : 1B	Calculated
Gel Time at 25°C, 150g mass, min.	25	ASTM D2471

### PHYSICAL PROPERTIES

	CPD 9292B	Test Method
Color	Straw Yellow	Visual
Izod Impact, Notched, ft-lb/in	1.10	ASTM D256
Tensile Strength, psi	9,700	ASTM D638
Tensile Modulus, psi	402,000	ASTM D638
Tensile Elongation, %	6.8	ASTM D638
HDT, Room Temp Cure, °F	135	ASTM D648
Compressive Strength, psi	13,100	ASTM D695
Flexural Strength, psi	16,000	ASTM D790
Flexural Modulus, psi	451,000	ASTM D790
Hardness, Shore D	80	ASTM D2240
Linear Shrinkage, in/in	<0.002	ASTM D2566

### SYSTEM POST CURE OPTIONS:

Select one of the following cure schedules depending on the available time, the physical properties of the mold and the desired physical properties of the final part. Post cure the part to obtain maximum physical and thermal properties of the system. The recommended post cure temperature ramp rate between stages is up 5°F per minute for heating and down 1-2°F per minute for cooling. Heating and cooling ramp rates can vary based on size and thickness of the part. For larger thicker parts use a more conservative ramp. If you need to deviate from the recommended post cure schedule, please contact our technical service department.

### CURE INCREMENTS:

CPD 9292B	24 Hours at 77°F (25°C)	7 Days at 77°F (25°C)	4 Hours at 150°F (66°C)
Room Temperature Cure	Supported	Unsupported	
Post Cure	Supported		Unsupported

### MIXING AND SURFACE PREP:

Always use the recommended mix ratio for the system. Do not deviate in an attempt to speed up or slow down gel time. Mix together thoroughly, scraping sides and bottom of mixing container, until no streaks or striations are visible, then use immediately. Use only clean dry tools for mixing and applying. Do not mix or apply below 60°F. All surfaces must be clean, dry, and free of any surface contamination. Molds and patterns should be treated with release or parting agents.

### STORAGE AND CRYSTALLIZATION:

Store between 60-90°F in a dry place. After use, tightly reseal all containers and store products on a raised surface during cold weather and avoid storing near outside walls or doors. If available, Purge with dry nitrogen to preserve color and minimize moisture contamination. Do not allow to freeze during winter storage. Do not use material with any signs of crystallization such as solid chunks, grainy texture or white color. Crystallization can be reversed by heating the material to 125-140°F, and stirring occasionally, until all crystals dissolve.

### SAFETY HANDLING:

Wear protective gloves, clothing, and eye/face protection. Use only outdoors or in a well-ventilated area. Avoid contact to the skin and eyes. Avoid breathing dust, fumes, gas mist, vapors and spray. Wash hands thoroughly after handling. Take off contaminated clothing and wash before reuse. These products may cause skin and respiratory allergic reactions. Consult product Safety Data Sheets for complete precautions for use of this product.

Polytek Development Corp. has experience only in the compounding of resins and hardeners and not in the actual manufacture of tools or parts. Each piece is different. The user should run tests to assure the suitability of the system for use in a particular application. The test data and results set forth herein are based on laboratory work and do not necessarily indicate the results that the buyer or user will attain.

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